

**Single Phase 0.8Amp Glass passivated Bridge Rectifiers**

**MBF**

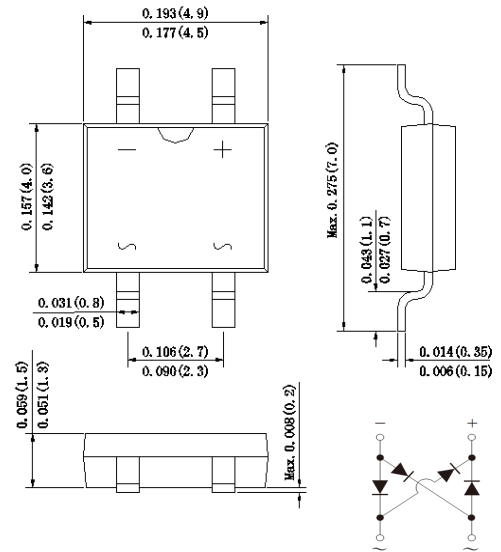


**Features**

- ◆ The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- ◆ Idea for printed circuit board
- ◆ Glass passivated junction chip
- ◆ Low reverse leakage
- ◆ High forward surge current capability
- ◆ High temperature soldering guaranteed  
260°C/10 seconds at terminals

**Mechanical Data**

- Case :** Molded plastic body  
**Terminals :** Solder plated, solderable per MIL-STD-750, Method 2026  
**Polarity :** Polarity symbol marking on body  
**Mounting Position :** Any  
**Weight :** 0.0027 ounce, 0.078 grams



Dimensions in inches and (millimeters)

**Maximum Ratings And Electrical Characteristics**

Ratings at 25°C ambient temperature unless otherwise specified. Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Parameter	SYMBOLS	MB05F	MB1F	MB2F	MB4F	MB6F	MB8F	MB10F	UNITS
Maximum repetitive peak reverse voltage	$V_{RRM}$	50	100	200	400	600	800	1000	V
Maximum RMS voltage	$V_{RMS}$	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	$V_{DC}$	50	100	200	400	600	800	1000	V
Maximum average forward rectified current at $T_L=100^\circ C$ On glass-epoxy P.C.B (Note 1)	$I_{AV}$	0.8							A
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	$I_{FSM}$	30.0							A
Rating for fusing ( $t=8.3ms, T_a=25^\circ C$ )	$I_t^2$	3.73							$A^2_s$
Maximum instantaneous forward voltage at 0.8A	$V_F$	1.0							V
Maximum DC reverse current $T_A = 25^\circ C$ at rated DC blocking voltage $T_A = 125^\circ C$	$I_R$	2.0 200							$\mu A$
Typical junction capacitance (Note 2)	$C_J$	15.0							pF
Typical thermal resistance	$R_{qJA}$	76.0							$^\circ C/W$
Operating junction and storage temperature range	$T_J, T_{STG}$	-55 to +150							$^\circ C$

**Note:** 1. Mounted on glass epoxy PC board with 1.3\*1.3mm solder pad  
 2. Measured at 1MHz and applied reverse voltage of 4.0V D.C.

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**Ratings And Characteristic Curves**

FIG. 1- DERATING CURVE OUTPUT RECTIFIED CURRENT

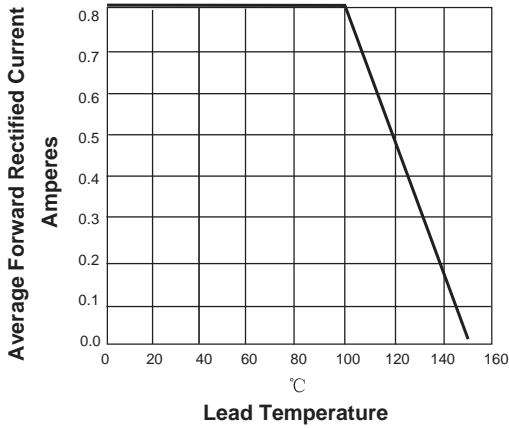


FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT PER LEG

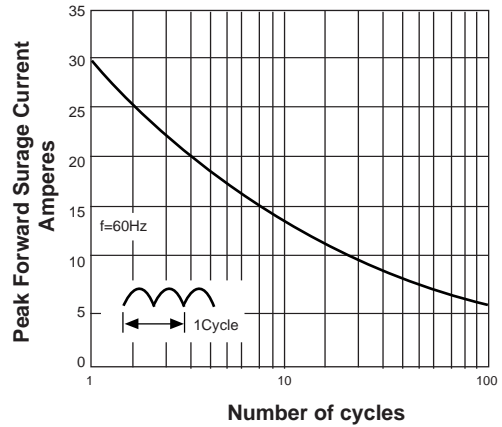


FIG. 3-TYPICAL FORWARD VOLTAGE CHARACTERISTICS

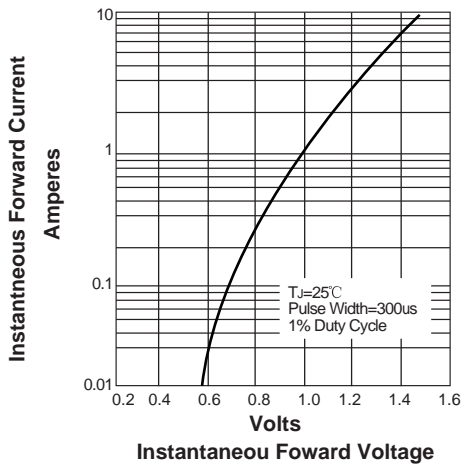
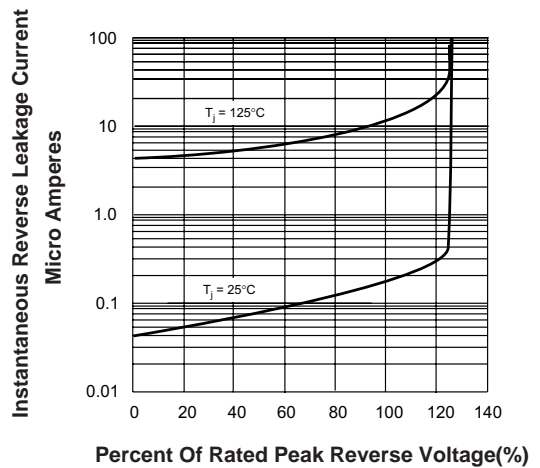
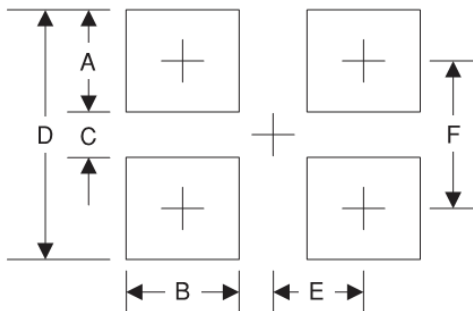


FIG. 4-TYPICAL REVERSE LEAKAGE CHARACTERISTICS



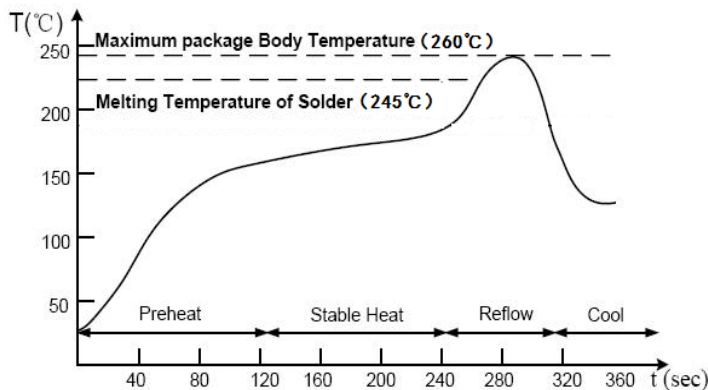
**Suggested Pad Layout**



Symbol	Unit (mm)	Unit (inch)
A	1.7	0.067
B	1.0	0.039
C	4.40	0.173
D	8.10	0.319
E	1.25	0.049
F	6.30	0.248

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**Suggested Soldering Temperature Profile**

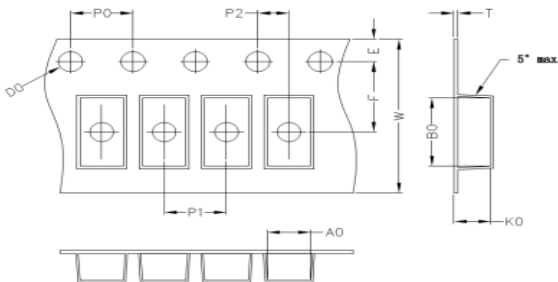


**Note**

- Recommended reflow methods: IR, vapor phase oven, hot air oven, wave solder.
- The device can be exposed to a maximum temperature of 260°C for 10 seconds.
- Devices can be cleaned using standard industry methods and solvents.
- If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

**Package Information**

**Carrier Dimension(mm)**



A0	B0	K0	D0	E	F
5.05	7.10	1.65	1.55	1.75	5.50
P0	P1	P2	T	W	Tolerance
4.0	8.0	2.0	0.25	12	0.1

**Package Specifications**

Package	Reel Size	Reel DIA. (mm)	Q'TY/Reel (Kpcs)	Box Size (mm)	QTY/Box (Kpcs)	Carton Size (mm)	Q'TY/Carton (Kpcs)
MBF	11'	278	3	280	6	355*310*310	48
	13'	330	5	338	10	365*365*360	80